


<b>PCN Number:</b>	20240129003.0		<b>PCN Date:</b>	February 02, 2024
<b>Title:</b>	Datasheet for TMS320F28003x			
<b>Customer Contact:</b>	Change Management team	<b>Dept:</b>	Quality Services	
<b>Change Type:</b>	Electrical Specification			
<b>PCN Details</b>				
<b>Description of Change:</b>				
<p>Texas Instruments Incorporated is announcing an information only notification.  The product datasheet(s) is being updated as summarized below.  The following change history provides further details.</p> <div style="display: flex; justify-content: space-between; align-items: flex-end;"> <div style="text-align: center;">  </div> <div style="text-align: right;"> <p><b>TMS320F280039C, TMS320F280039C-Q1, TMS320F280039-Q1, TMS320F280038C-Q1</b>  <b>TMS320F280037C, TMS320F280037C-Q1, TMS320F280037, TMS320F280036C-Q1</b>  <b>TMS320F280036-Q1, TMS320F280034, TMS320F280034-Q1</b></p> <p><small>SPRSP61C – OCTOBER 2021 – REVISED DECEMBER 2023</small></p> </div> </div>				

## Changes from November 30, 2022 to December 7, 2023

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• <b>This Revision History lists the changes from SPRSP61B to SPRSP61C.</b>	1
• <b>Global:</b> Added TMS320F280033-Q1 device [Preview information (not Production Data)].	1
• <b>Global:</b> Information on the TMS320F280039-Q1, TMS320F280039, TMS320F280038-Q1, TMS320F280037-Q1, TMS320F280036C-Q1, TMS320F280036-Q1, TMS320F280034-Q1, and TMS320F280033 devices is now Production Data.	1
• <b>Global:</b> TMS320F280039C-Q1, TMS320F280039-Q1, TMS320F280037C-Q1, and TMS320F280034-Q1 are now available in the 80-pin PN package.	1
• <b>Features</b> section: Changed Security features under "On-chip memory" feature.	1
• <b>Features</b> section: Updated "Functional Safety-Compliant" feature and "Safety-related certification" feature.	1
• <b>Package Information</b> table: Added table.	3
• <b>Functional Block Diagram</b> figure: Updated "Buses Legend" by changing "CLU" to "CLA".	6
• <b>Device Comparison</b> table: Changed "Code security for on-chip flash and RAM" to "Security: JTAGLOCK, Zero-pin boot, Dual-zone security".	8
• <b>Device Comparison</b> table: Changed the number of ADC channels for the 100-pin PZ package from 23 to 25.	8
• <b>Device Comparison</b> table: TMS320F280039C-Q1, TMS320F280039-Q1, TMS320F280037C-Q1, TMS320F280034-Q1, and TMS320F280033-Q1 are now available in the 80-pin PN package.	8
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• <b>Block Diagram</b> section: Added "Each reference 12-bit DAC can be configured to drive a reference voltage into the negative input of the respective comparator" paragraph. Added "Reference DAC Block Diagram" figure.	136
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The datasheet number will be changing.

Device Family	Change From:	Change To:
<a href="#">TMS320F28003x</a>	SPRSP61B	<b>SPRSP61C</b>

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TMS320F280039C>

#### Reason for Change:

To accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

F280037CSPM	F280037CSPTR	F280039SPZ	F280037SPT
F280036PMRQ1	F280036CPMRQ1	F280038PMRQ1	F280037SPZ
F280034SPZ	F280033SPZ	F280037CSPN	F280033SPN
F280039CSPNR	F280039CSPMR	F280037SPMR	F280037PTRQ1
F280039CSPZ	F280037SPM	F280034SPM	F280037CSPZ
F280039CSPZR	F280037SPNR	F280034SPN	F280037SPN
F280039SPM	F280034PTRQ1	F280039CPZRQ1	F280034SPT
F280039SPN	F280033SPM	F280039CSPN	F280033SPT
F280037CPTQ1	F280039CPZQ1	F280037PZRQ1	F280038CPMRQ1
F280037CPTRQ1	F280039CSPM	F280039PZRQ1	F280038CPMQ1
F280037CSPT	F280037CPZRQ1		

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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